**Notion** Module



## **Notion M12 LTE CAT-1 Module Owner's Manual**

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# **Notion**

**Notion M12 LTE CAT-1 Module** 



## **Product Specifications**

• Product Name: Notion LTE CAT-1 Module M12

- Wireless Data Communication Module
- Supports TDD-LTE and FDD-LTE Network Modes
- Package Size: 23\*23\*2.3mm
- 65 External LCC Pads, 49 Bottom LGA Pads
- Built-in Compatible Bluetooth Function

#### **Product Usage Instructions**

## • Band Support:

The module supports various LTE bands including FDD and TDD bands.

## • Functional Block Diagram:

The module features a functional block diagram to illustrate its internal components and connections.

#### • Interface:

The module provides multiple interfaces for GPIO, power supply, USB, LCD control, GPS, SIM card, and more.

#### • Power Supply:

The module requires a power supply of 3.3V to 4.3V with a typical voltage of 3.8V.

#### • GPIO Pins:

The module has GPIO pins for controlling LED lights, LCD backlight, key backlight, charging status, GPS communication, LCD interface, SIM card communication, and more.

The M12 module is a CAT-1 wireless data communication module that supports TDD-LTE and FDD-LTE network modes. M12 adopts an LCC package, the overall size is 23\*23\*2.3mm, 65 external LCC pads, 49 bottom LGA pads, small size, rich peripheral interface, and simple peripheral circuit, at the same time, the product built-in compatible Bluetooth function, bringing more options for customers differentiated design.

## **Band support**

#### China

- LTE(FDD): 1/3/5/8
- LTE(TDD):34/38/39/40/41n

## • Europe/Africa/Middle East/Southeast Asia/South Asia/Korea

- LTE(FDD): 1/2/3/4/5/7/8/20/28
- LTE(TDD):34/38/39/40/41n

#### Latin America

- LTE(FDD):1/2/3/4/5/7/8/12/13/17/66
- LTE(TDD):38/40/41n general characteristic
- Working Temperature:-30°C~75°CHumidity: 5% 95%
  - Power supply: 3.3-4.3V typical:3.8V
  - Power dissipation 3-15mA @3.8V
  - Size: 23\*23\*2.3mm
  - AT command: 3GPP TS 27.007 and 27.005
  - · Operating system:
- Windows/Linux/Android

#### RF characteristics

Transmitted power

LTE: +21dBm (3GPP TS 36.101 R9 Class 3) Rate

• LTE Cat 1: DL 10Mbps / UL 5Mbps

## Functional block diagram

#### Interface

- PWM\*3
- USB 2.0\*1
- Uart \*2
- SDIO \*1
- ADC \*2
- I2C \*1
- SPI \*1
- KEY MATRIX:6\*6
- USIM\*2
- AUDIO\*1
- · Antenna: LTE, BT
- Sensitivity
  - FDD B1 -99dBm(10M) FDD B2 -97.5dBm(10M) FDD B3 -99dBm(10M) FDD B4 -100dBm(10M) FDD B5 99dBm(10M) FDD B7 -99dBm(10M) FDD B8 -99dBm(10M) TDD B12 -100dBm(10M) TDD B13 99.5dBm(10M) TDD B17 -100.5dBm(10M) FDD B20 -98.5dBm(10M) FDD B28 -99.5dBm(10M) TDD B34 -100.5dBm(10M) TDD B38 -100dBm(10M) TDD B39 -100.5dBm(10M) TDD B40 -100.5dBm(10M) TDD B41 -100.5dBm(10M) TDD B66 -100dBm(10M)

PI N	PIN Name	PIN GPI O	I/O	Description	Remark column
1	LED1_CTRL	GPIO 21	0	The LED_CTRL controls the LED light	MMC1_DAT2
		G. 10_E1		through an external triode  KP_LED_PWM4 controls the key backli	1,000
2	KP_LED_PWM4	GPIO_11	0	ght through an external triode  The LCD_BL_PWM3 controls the LCD	I2C2_SDA/PWM4
3	LCD_BL_PWM3	GPIO_10	0	backlight through an external triode	I2C2_SCL/PWM3
4	GND	/	/	/	/
5	GND	/	/	/	1
6	GND	/	/	1	/
7					The layout width must be
9	VBAT	/	PI	Power Supply:3.3to4.3V(typical:3.8V)	no less than 1.5mm
10	USB_VBUS	/	PI	USB status detection pin	/
11	CHG_STAT	GPIO_32	I	Charging status detection pin of external charging chip	PWM2
12	CHG_EN	GPIO_22	0	Enable pin for external charging chip	MMC1_DAT1
13	GPS_VBACKU P	/	РО	GPS RTC standby power supply pin	/
14	VLDO7_GPS_3 V3	/	РО	Power supply for the external GPS module	Max current 100mA
15	GPS_UART3_T XD	GPIO_15	I/O	External GPS module serial communication RX pin	
16	GPS_UART3_R XD	GPIO_14	I/O	External GPS module serial communication TX pin	If the external GPS modul e is 3.3V, TX/RX requires I evel conversion to 3.3V

				1.8V LDO Output can be used to pull up	
17	VLDO2_1V8	/	PO	the GPIO or the LCD screen I/O power s upply or the built-in Bluetooth power supply	Max current 200mA
18	VLDO6_LCD_2 V8	/	РО	LCD screen power supply and RF switch power supply	Max current 100mA
19	LCD_RST	GPIO_12 4	0	The reset pin for the LCD serial peripher al interface	/
20	LCD_LDO_EN	GPIO_12 1	0	Enable control pin for LCD External Power supply (LDO)	/
21	LCD_CS0	GPIO_34	0	Slave selection pin for LCD serial peripheral interface	/
22	LCD_SPI_DATA	GPIO_36	0	Data pin for LCD serial peripheral interface	UART3_TXD
23	LCD_SPI_RS	GPIO_35	0	Command pin for LCD serial peripheral interface	UART3_RXD
24	LCD_SPI_CLK	GPIO_33	0	Clock signal pin for LCD serial periphera I interface	/
25	GND	/	/	1	/
26	VLDO8_3V0_U S IM2	/	PO	SIM card 2 Power supply	The module automatically recognizes the 1.8V or 3.0 V SIM card
27	USIM2_CLK	GPIO_45	0	SIM card 2 clock pin	I2C4_SCL/GPIO45
28	USIM2_RST_N	GPIO_47	0	SIM card 2 Reset pin	
29	USIM2_DATA	GPIO_46	0	SIM card 2 data pin	I2C4_SDA/GPIO46
30	VLDO3_3V0_U S IM	/	РО	SIM card 1 Power supply	The module automatically recognizes the 1.8V or 3.0 V SIM card

31	USIM_CLK	/	0	SIM card 1 clock pin	/
32	USIM_RST_N	/	0	SIM card 1 Reset pin	1
33	USIM_DATA	/	0	SIM card 1 data pin	1
34	GND	/	/	/	1
35	USB_DP	/	I/O		The wiring requires 90Ω
36	USB_DN	/	I/O	USB differential data signal	differential impedance
37	EAR_N	/	AO	Audio differential data signal	
38	EAR_P	/	AO	Audio differential data Signal	
39	SPKPA_EN	GPIO_80	0	Audio PA enables control pin	1
40	MIC_P	/	Al	Audio MIC input	1
41	MICBIAS	/	0	Audio MICBIAS	1
				Audio MICBIAS is controlled by a triode to	
42	MICBIAS_CTL	GPIO_37	0	switch the onboard MIC/ headset MIC pi	
43	HP_DET	GPIO_79	1	Earphone insert detection pin	/
44	HEAD_PTT	GPIO_78	1	Headset PTT enable pin. Active low	1
45	CI2C_SCL	GPIO_49	I/O	I2C clock pin	1
46	CI2C_SDA	GPIO_50	I/O	I2C data pin	1
47	GND	/	/	/	1
48	GND	/	/	/	1
49	RF_ANT	/	AI/ O	Rf antenna pin	/
50	GND	/	/	/	1
51	GND	/	/	/	1
52	MK_OUT_0	GPIO_01	I/O	input detection pin for matrix keys/individual keys	/
53	MK_IN_0	GPIO_00	I/O	input detection pin for matrix keys/individual keys	/
54	MK_IN_1	GPIO_02	I/O	input detection pin for matrix keys/individual keys	UART4_RXD

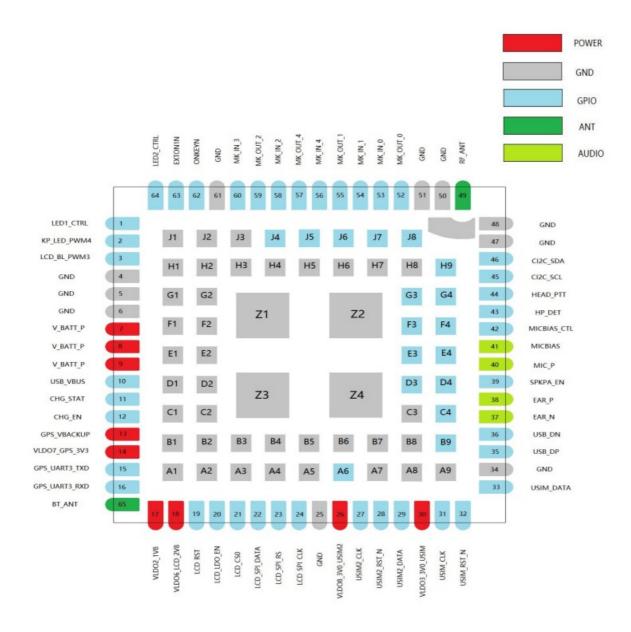
55	MK_OUT_1	GPIO_03	I/O	input detection pin for matrix keys/individual keys	UART4_TXD
56	MK_IN_4	GPIO_08	I/O	input detection pin for matrix keys/individual keys	PWM1/PWM3
57	MK_OUT_4	GPIO_09	I/O	input detection pin for matrix keys/individual keys	PWM2/PWM4/MKOUT[4]: A low level is detected during power on , enter USB download mode
58	MK_IN_2	GPIO_04	I/O	input detection pin for matrix keys/individual keys	UART4_RXD/SSP1_SCLK
59	MK_OUT_2	GPIO_05	I/O	input detection pin for matrix keys/individual keys	UART4_TXD/SSP1_FRM
60	MK_IN_3	GPIO_06	I/O	input detection pin for matrix keys/individual keys	PWM3/SSP1_RXD
61	GND	/	/	1	/
62	OKAY	/	I	In the off state, the pin continues to pull down for 3S to power on, and in the on s tate, the pin continues to pull down for 5S to power off	Do not pull down directly; otherwise, the system will restart continuously
63	EXTON1N	/	I	Directly pull down the EXTON1N pin an d power it on automatically. Keep this pin NC if not used.	/
64	LED2_CTRL	GPIO_24	0	The LED2_CTRL controls the LED light through an external triode	MMC1_DAT0
A1	GND	/	/	1	/
		T	I		
Δ2	GND	/	/		l <i>I</i>

A2	GND	/	/	/	/
A3	GND	/	/		/
A4	GND	1	/	1	1

<b>A</b> 5	GND	/	/	1	/
A6	CP_UART_DTR	GPIO_27	I/O	CP Data Terminal Ready	MMC1_CLK
A7	GND	/	/	1	/
A8	GND	/	/	1	/
A9	GND	/	/	1	/
B1	GND	/	/	1	/
B2	GND	/	/	1	/
В3	GND	/	/	1	/
B4	GND	/	/	1	/
B5	GND	/	/	1	/
В6	GND	/	/	1	/
В7	GND	/	/	1	/
В8	GND	/	/	1	/
				input detection pin for matrix	
B9	MK_OUT_3	GPIO_07	I/O	keys/individual keys	PWM4/SSP1_TXD
C1	GND	/	/	/	1
C2	GND	/	/	/	1
СЗ	GND	/	/	/	1
C4	MK_OUT_6	GPIO_13	I/O	input detection pin for matrix keys/individual keys	I2C3_SDA
D1	GND	/	/	/	/
D2	GND	/	/	1	/
D3	GPIO_23	GPIO_23	I/O	1.8V power domain, GPIO, Keep this pin NC if not used.	
D4	MK_IN_6	GPIO_12	I	input detection pin for matrix keys/individual keys	I2C3_SCL
E1	GND	1	/	/	/
E2	GND	1	/	/	/
E3	LCD_TE	GPIO_26	0	frame synchronization signal for LCD_SPI serial peripheral interface	I2C4_SDA/MMC1_CLK

E4	AP_UART1_RX	GPIO_29	1	AP serial data receiving pin	
F1	GND	1	/	/	/
F2	GND	/	/	/	/
F3	USIM_CD	GPIO_25	I/O	SIM Card Insertion Detection Pin (reserved)	I2C4_SCL/MMC1_CMD
F4	AP_UART1_TX	GPIO_30	0	AP serial data sending pin	default Print log
G1	GND	/	/	/	/
G2	GND	1	/	/	/
G3	CP_UART_CTS	GPIO_53	I/O	CP serial interface clears the transmit signal pin	UART3_RXD/MMC1_DA
G3	CP_UART_CTS CP_UART_RXD	GPIO_53	I/O		
		_		signal pin	T1
G4	CP_UART_RXD	GPIO_51	I	signal pin  CP serial input pin	T1  MMC1_DAT3
G4 H1	CP_UART_RXD GND	GPIO_51	I /	signal pin  CP serial input pin  /	T1  MMC1_DAT3  /
G4 H1 H2	CP_UART_RXD GND GND	GPIO_51 /		signal pin  CP serial input pin  /	T1  MMC1_DAT3  /
G4 H1 H2 H3	CP_UART_RXD GND GND GND	GPIO_51 / /		signal pin  CP serial input pin  /  /	T1  MMC1_DAT3  /  /  /
G4 H1 H2 H3	CP_UART_RXD GND GND GND GND	GPIO_51 / /		signal pin  CP serial input pin  /  /  /	T1  MMC1_DAT3  /  /  /  /
G4 H1 H2 H3 H4	GND GND GND GND GND GND GND	GPIO_51 / / / /		signal pin  CP serial input pin  /  /  /  /  /	T1  MMC1_DAT3  /  /  /  /  /

Н9	CP_UART_RTS	GPIO_54	I/O	CP serial interface request send pin	UART3_TXD/MMC1_DA		
J1	GND	/	/	1	/		
J2	GND	/	/	/	/		
J3	GND	/	/	/	1		
J4	AUXADC_IN3	/	AI	ADC Extended interface can support high voltage battery capacity detection	1V8 or 1V2 power		
J5	AUXADC_IN	/	AI	The ADC_IN2 interface is used to collec t the signal of the potentiometer volume	domain,default:1V2 power domain		
J6	CP_UART_RI	GPIO_31	I/O	CP serial ring indicating pin	MMC1_CMD		
J7	TORCH_PWM1	GPIO_12 6	0	default: Flashlight brightness control pin	PMW1/PWM4		
J8	CP_UART_TXD	GPIO_52	I/O	CP serial output pin	MMC1_DAT2		
Z1	GND	/	/	1	1		
Z2	GND	1	/	/	1		
Z3	GND	1	/	1	1		
Z4	GND	/	/	/	/		
65	ANT	/	AI/ O		/		
/	Note All the above I/O interfaces belong to the 1.8V voltage domain unless specified						



#### **FCC WARNING**

**FCC Caution**: Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment. This device complies with Part 15 of the FCC Rules.

#### Operation is subject to the following two conditions:

- 1. This device may not cause harmful interference, and
- 2. this device must accept any interference received, including interference that may cause undesired operation.

This device and its antenna(s) must not be co-located or operating in conjunction with any other antenna or transmitter.

- · Information to the user.
- For a Class B digital device or peripheral, the instructions furnished to the user shall include the following or similar statement, placed in a prominent location in the text of the manual:

Note: This equipment has been tested and found to comply with the limits for a Class B digital device, under part

15 of the FCC Rules.

These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used by the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and the receiver.
- Connect the equipment to an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with a minimum distance of 20cm between the radiator and your body. Radiation Exposure Statement: This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. The availability of some specific channels and/or operational frequency bands are country-dependent and are firmware programmed at the factory to match the intended destination. The firmware setting is not accessible by the end user.

The end product must be labeled in a visible area with the following: "Contains Transmitter Module "FCC ID: 2AR45-M12"

## Requirement per KDB996369 D03

## List of applicable FCC rules

- List the FCC rules that apply to the modular transmitter. These are the rules that specifically establish the bands of operation, the power, spurious emissions, and operating fundamental frequencies. DO NOT list compliance to unintentional-radiator rules (Part 15 Subpart B) since that is not a condition of a module grant that is extended to a host manufacturer. See also Section 2.10 below concerning the need to notify host manufacturers that further testing is required.3
- Explanation: This module meets the requirements of FCC parts 22 24 27.it Specifically identified Conducted
  output power, Effective Radiated Power of Transmitter(EIRP), peak-to-average ratio, 99% & 26dB Occupied
  Bandwidth, Band Edge at antenna terminals, Spurious emissions at antenna terminals, Field strength of
  spurious radiation Frequency stability.

## Summarize the specific operational use conditions.

Describe use conditions that apply to the modular transmitter, including for example any limits on antennas, etc. For example, if point-to-point antennas are used that require a reduction in power or compensation for cable loss, then this information must be in the instructions. If the use condition limitations extend to professional users, then instructions must state that this information also extends to the host manufacturer's instruction manual. In addition, certain information may also be needed, such as peak gain per frequency band and minimum gain, specifically for master devices in 5 GHz DFS bands.

Explanation: The product antenna uses an irreplaceable antenna with a gain of 0dBi 2.4 Single Modular

If a modular transmitter is approved as a "Single Modular," then the module manufacturer is responsible for

approving the host environment that the Single Modular is used with. The manufacturer of a Single Modular must describe, both in the filing and the installation instructions, the alternative means that the Single Modular manufacturer uses to verify that the host meets the requirements to satisfy the module limiting conditions. A Single Modular manufacturer has the flexibility to define its alternative method to address the conditions that limit the initial approval, such as shielding, minimum signaling amplitude, buffered modulation/data inputs, or power supply regulation. The alternative method could include the limited module manufacturer reviewing detailed test data or host designs before giving the host manufacturer approval.

This Single Modular procedure is also applicable for RF exposure evaluation when it is necessary to demonstrate compliance in a specific host. The module manufacturer must state how control of the product into which the modular transmitter will be installed will be maintained such that full compliance with the product is always ensured. For additional hosts other than the specific host originally granted a limited module, a Class II permissive change is required on the module grant to register the additional host as a specific host also approved with the module.

**Explanation**: The module is a single module.

## Trace antenna designs

For a modular transmitter with trace antenna designs, see the guidance in Question 11 of KDB Publication 996369 D02 FAQ – Modules for Micro-Strip Antennas and Traces. The integration information shall include for the TCB review the integration instructions for the following aspects: layout of trace design, parts list (BOM), antenna, connectors, and isolation requirements.

- Information that includes permitted variances (e.g., trace boundary limits, thickness, length, width, shape(s), dielectric constant, and impedance as applicable for each type of antenna);
- Each design shall be considered a different type (e.g., antenna length in multiple(s) of frequency, the wavelength, and antenna shape (traces in phase) can affect antenna gain and must be considered);
- The parameters shall be provided in a manner permitting host manufacturers to design the printed circuit (PC) board layout;
- · Appropriate parts by manufacturer and specifications; e) Test procedures for design verification; and
- Production test procedures for ensuring compliance

The module grantee shall provide a notice that any deviation(s) from the defined parameters of the antenna trace, as described by the instructions, requires that the host product manufacturer notify the module grantee that they wish to change the antenna trace design. In this case, a Class II permissive change application is required to be filed by the grantee, or the host manufacturer can take responsibility through the change in FCC ID (new application) procedure followed by a Class II permissive change application.

## RF exposure considerations

It is essential for module grantees to clearly and explicitly state the RF exposure conditions that permit a host product manufacturer to use the module. Two types of instructions are required for RF exposure information:

- 1. To the host product manufacturer, to define the application conditions (mobile, portable xx cm from a person's body); and
- 2. Additional text is needed for the host product manufacturer to provide to end users in their end-product manuals. If RF exposure statements and use conditions are not provided, then the host product manufacturer is required to take responsibiliforfor the ule through a change in FCC ID (new application).

Explanation: The module complies with FCC radiofrequency radiation exposure limits for uncontrolled environments. The device is installed and operated with a distance of more than 20 cm between the radiator and your body." This module follows the FCC statement design, FCC ID: 2AR45-M12

#### **Antennas**

A list of antennas included in the application for certification must be provided in the instructions. For modular transmitters approved as limited modules, all applicable professional installer instructions must be included as part of the information to the host product manufacturer. The antenna list shall also identify the antenna types (monopole, PIFA, dipole, etc. (note that for example an "omnidirectional antenna" is not considered to be a specific "antenna type").

For situations where the host product manufacturer is responsible for an external connector, for example with an RF pin and antenna trace design, the integration instructions shall inform the installer that a unique antenna connector must be used on the Part 15 authorized transmitters used in the host product.

The module manufacturers shall provide a list of acceptable unique connectors.

Explanation: The product antenna uses an irreplaceable antenna with a gain of 0dBi

## Label and compliance information

Grantees are responsible for the continued compliance of their modules to the FCC rules. This includes advising host product manufacturers that they need to provide a physical or e-label stating "Contains FCC ID" with their finished product. See Guidelines for Labeling and User Information for RF Devices – KDB Publication 784748.

**Explanation**: The host system using this module, should have a label in a visible area indicating the following texts: "Contains FCC ID: 2AR45-M12

### Information on test modes and additional testing requirements

- Additional guidance for testing host products is given in KDB Publication 996369 D04 Module Integration
  Guide. Test modes should take into consideration different operational conditions for a stand-alone modular
  transmitter in a host, as well as for multiple simultaneously transmitting modules or other transmitters in a host
  product.
  - The grantee should provide information on how to configure test modes for host product evaluation for different operational conditions for a stand-alone modular transmitter in a host, versus with multiple, simultaneously transmitting modules or other transmitters in a host.
- Grantees can increase the utility of their modular transmitters by providing special means, modes, or instructions that simulate or characterize a connection by enabling a transmitter. This can greatly simplify a host manufacturer's determination that a module as installed in a host complies with FCC requirements.

**Explanation**: Shanghai Notion Information Technology CO. LTD can increase the utility of our modular transmitters by providing instructions that simulate or characterize a connection by enabling a transmitter.

#### Additional testing, Part 15 Subpart B disclaimer

The grantee should include a statement that the modular transmitter is only FCC-authorized for the specific rule parts (i.e., FCC transmitter rules) listed on the grant and that the host product manufacturer is responsible for compliance with any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. If the grantee markets their product as being Part 15 Subpart B compliant (when it also contains unintentional radiator digital circuity), then the grantee shall provide a notice stating that the final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

**Explanation**: The module without unintentional-radiator digital circuity, so the module does not require an evaluation by FCC Part 15 Subpart B. The host should be evaluated by the FCC Subpart B.

#### **FAQ**

#### Q: What are the dimensions of the M12 module?

A: The M12 module has an overall size of 23\*23\*2.3mm.

## Q: What network modes does the M12 module support?

A: The M12 module supports TDD-LTE and FDD-LTE network modes.

## Q: Does the M12 module have built-in Bluetooth functionality?

A: Yes, the M12 module has a built-in compatible Bluetooth function.

## **Documents / Resources**



## Notion M12 LTE CAT-1 Module [pdf] Owner's Manual

2AR45-M12, 2AR45M12, M12 LTE CAT-1 Module, M12, LTE CAT-1 Module, CAT-1 Module, Module, CAT-1 Module, Module, M12, LTE CAT-1 Module, CAT-1 Module, M12, LTE CAT-1 M0dule, M12, LTE CAT-

## References

- ONOTION official website
- User Manual

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